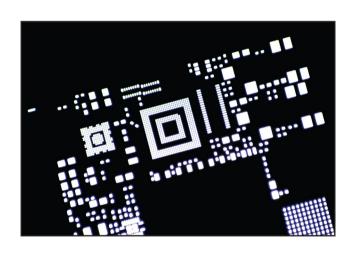


## CYBERSOLV® 13400

Stencil Cleaning Solvent

CYBERSOLV C3400 is a solvent blend designed to remove all raw solder pastes in stencil cleaning applications while remaining compatible with materials commonly used in stencil construction. C3400 is convenient because it is used as received at ambient temperatures.



- Multi-process: Immersion, manual, automated stencil wipe
- Fast drying
- MPM approved
- No odor, no residue & self rinsing
- Compatible with wetted components common in understencil wipe systems

PRODUCT PROPERTIES	
pH (10g/L)	Not Applicable
FLASH POINT	142°F / 61°C
BOILING POINT	358°F / 181°C
WATER SOLUBLE	Partial
VOC, @ 100%	753.8 g/L

## TYPICAL PROCESSES

APPLICATION Manual, Underscreen, Immersion, Stencil Wipe

CONCENTRATION 100%

TEMPERATURE <125°F/51°C

RINSE Thoroughly

**DRY** Air

The above process parameters are recommendations based on extensive testing done in KYZEN's application lab. Your KYZEN sales representative can assist you in optimizing your process parameters.

## STORAGE AND HANDLING

- Packaged in Polyethylene Containers
- Store at 5-30°C/41-86°F in Original Container
- Standard Chemical Handling Practices
- Shelf Life of Sealed Containers:
  - 1 Year 1 gallon/5 liters
  - 5 Year 5 gallons/25 liters or more

## **AVAILABILITY**

- 1 Gallon
- 5 Liters\*
- 5 Gallons
- 25 Liters\*
- 55 Gallons
- 200 Liters\*
- \* Liters Available in South Asia and Europe